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BT

Sub C

68. (Amended) A chip package comprising:
packaging material having a first side and a second side,
a lead extending from the first side of the packaging material, and
a first clip portion extending from the second side of the packaging
material.

69. (Amended) The chip package of claim 68, the packaging material
having a third side, and further comprising a second clip portion extending from
the third side of the packaging material.

B2

Sub D1

80. (Amended) The chip package of claim 79, wherein the metallic
material comprises beryllium-copper.

Please cancel claim 84

In the Specification

Please amend on page 35, the third beginning paragraph, and which extends
to page 36, that before this subject amendment begins "For another embodiment,
an edge-mountable chip 2040 may have a C-shaped leads 2042 that wrap around a
cylinder 2080 extending along the ..." to read as follows:

B2

--For another embodiment, an edge-mountable chip 2040 may have
a C-shaped leads 2042 that wrap around a cylinder 2080 extending
along the bottom of chip 2040 from left to right as illustrated in
Figure 22. Leads 2042 extend into a pocket or indentation formed
by an extended portion 2041 of chip 2040. The pocket formed by